



SiPM news

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Neutron fluxes at the dRICH photosensor surface

1-MeV neutron equivalent fluence (1 fb⁻¹ ep running)



assume fluence: ~ 10^7 neg / cm² / fb⁻¹ conservatively assume max fluence and 10x safety factor \rightarrow radiation damage studied in steps of radiation load 10^9 1-MeV n_{eq}/cm² most of the key physics topics 10¹⁰ 1-MeV n_{eq}⁴/cm² should cover most demanding measurements 10¹¹ 1-MeV n_{eo}³/cm² might never be reached



updated radiation simulations

New radiation damage estimates



xy projections in 210 < z < 260 cm region, average and max values reported for 100 < R < 180 cm region

New radiation damage estimates



before: max fluence = 9.2 10^5 neq/fb⁻¹ | now: max fluence = 1.75 10^7 neq/fb⁻¹ \Rightarrow new estimates are ~20x larger

New radiation damage estimates



new estimates are ~20x larger, but we had a 10x safety factor \Rightarrow we got the safety factor eaten and a 2x faster ageing

Updated ageing model



model input from R&D measurements (up to 2022)

- DCR increase: 500 kHz/10⁹ n_{en}
- residual DCR (online annealing): 50 kHz/10⁹ n_{eq}
- residual DCR (oven annealing): 15 kHz/10⁹ n_{eq}
- 1-MeV neq fluence from background group
 - 1.75 10⁷ n_{eq} / fb⁻¹
 - includes 2x safety factor

all parameters are the same used for the previous model only neq/fb⁻¹ is updated to new estimate, with 2x safety factor which corresponds to a 4x faster ageing than previously reported

Detailed studies of SiPM online self-annealing



test on a large number of proton irradiated sensors how much damage is cured as a function of temperature and time

in this study, the same sensors have undergone self-annealing in increasing temperature steps and increasing integrated time steps

- started with T = 100 C annealing
 performed 4 steps up to 30 hours integrated
- followed by T = 125, 150 and 175 C

fraction of residual damage seems to saturate at 2-3% after ~ 300 hours at T = 150 C continuing at higher T = 175 C seems

not to cure more than that

Detailed studies of SiPM online self-annealing





but, after many hours of online annealing

we noticed alterations on the SiPM windows in particular in one board that underwent

500 hours of online annealing at T = 175 C

the sensors appear "yellowish" when compared to new

less "yellowish" but still a bit "yellowish" the sensors in a board that underwent 500 hours at T = 150 C

let's compare them under the laser light

Detailed studies of SiPM online self-annealing





serious efficiency loss after 500 h online at 175 C 25% efficiency loss after 500 h online at 150 C no efficiency loss after 500 h oven at 150 C

0.5

pseudo-efficiency (%)

23
13

50

not clear why oven annealing is less critical on window, but in line with previously-reported "no damages due to annealing procedure" for 200 h in oven at T = 150 C

52

54

56

bias voltage (V)

58



Light response after irradiation and annealing



window damage studies

Detailed studies of SiPM window damage



measurements are ongoing

- 4 SiPM under study
- each undergoing online annealing
 - at forward bias
 - at different temperature
 - following the same annealing protocol
 - same integrated annealing time and cycles

measurements are performed with the upgraded laser setup (see next slides)

the plot reports the variation of the PDE wrt. the sensors measured before the beginning of the annealing cycles (new)

measurements are still ongoing so far, after 66 hours (66 1-hour cycles) no observation of efficiency loss at any temperature





upgraded laser setup

Old moving stage

workhorse! great results, despite limitations: only 2 axes, no low temperature operation, limited 25 mm range



Old moving stage

workhorse! great results, despite limitations: only 2 axes, no low temperature operation, limited 25 mm range



New moving stage

big upgrade! new xyz moving stage can operate at low temperature (down to T = -40 C) within a 200 mm range



New moving stage

big upgrade! new xyz moving stage can operate at low temperature (down to T = -40 C) within a 200 mm range



examples of laser operation

Signal extraction



Signal extraction



Signal extraction

measured signal coincidences

background-subtracted counts / triggers probability to detect light from laser pulse



Repeated measurements: signal

several measurements repeated on the same NEW sensor



don't know why the signal changes this much, same change in reference and sensor under study reference sensor measurement to quantify changes in the laser light yield

Repeated measurements: signal

several measurements repeated on the same NEW sensor



after correction for laser light yield, measurements of sensor under study are compatible

Repeated measurements: background

several measurements repeated on the same NEW sensor



there is likely some background light entering in the dark box reference sensor measurement to quantify changes in the background light

Repeated measurements: background

several measurements repeated on the same NEW sensor



after correction for background light, measurements of sensor under study are compatible

Repeated measurements: signal & background

powerful measurement of the SiPM performance: efficiency vs. dark count rate (or viceversa)



before correction

Repeated measurements: signal & background

powerful measurement of the SiPM performance: efficiency vs. dark count rate (or viceversa)



after correction for laser yield and background light, measurements of sensor under study are compatible

Comparison between sensors

3 Hamamatsu sensor types, 4 sensors each measured as NEW



proxy for photodetection efficiency

at the same level of detection efficiency

namely, the probability to detect light from laser pulse different sensors have different DCR level

best: S13360-3075

most promising sensors, large pitch SPADs (75 μm) second: S13360-3050

same technology, medium pitch SPADs (50 μm) worst: S14160-3050

different technology, medium pitch SPADs (50 μ m)

what follows is



new boards





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new boards and irradiated boards (10⁹ neq)





the Hamamatsu S14160-3050 sensors seem to have more troubles to be reconstructed after irradiation

new boards and irradiated boards (10⁹ neq)





the efficiency loss is likely due to the "after-pulse" suppression algorithm used for analysis "every signal which is within less than 100 ns wrt. the preceding signal is discarded" at ~ 1 MHz DCR rate, the probability of having a DCR hit 100 ns before the laser pulse is ~ 10% new boards and irradiated boards (10⁹ neq)





at fixed DCR of 500 kHz after 10⁹ neq (without annealing) the S13360-3075 sensor (75 m SPADs) is more efficient (20% larger PDE) caveat: new and irradiated are not the same sensors, so the comparison is not fully quantitative new boards and annealed boards (10⁹ neq)





the Hamamatsu S14160-3050 sensors seem to have lower efficiency after irradiation and annealing in S13360-3050 sensors the efficiency is unaffected, only DCR increases (we know) new boards and annealed boards (10⁹ neq)





the Hamamatsu S14160-3050 sensors seem to have lower efficiency after irradiation and annealing in S13360-3050 sensors the efficiency is unaffected, only DCR increases (we know)

prototype Hamamatsu sensors (10⁹ neq after oven annealing)



prototype Hamamatsu UVE sensors have significantly higher efficiency than standard sensors caveat: we only measure PDE at the fixed laser wavelength of ~400 nm, larger PDE expected because... prototype sensors have a NUV-enhanced (quartz + special silicone) protective window... might be of our interest to study further